# **BYQ30EB** series

### GENERAL DESCRIPTION

Glass passivated high efficiency rugged dual rectifier diodes in a plastic envelope suitable for surface mounting, featuring low forward voltage drop, ultra-fast recovery times and soft recovery characteristic. These devices can withstand reverse voltage transients and have guaranteed reverse surge and ESD capability. They are intended for use in switched mode power supplies and high frequency circuits in general where low conduction and switching losses are essential.

### PINNING - SOT404

### QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	MAX.	MAX.	UNIT
V <sub>RRM</sub>	BYQ30EB- Repetitive peak reverse voltage	<b>100</b> 100	<b>150</b> 150	<b>200</b> 200	v
V <sub>F</sub> I <sub>O(AV)</sub>	Forward voltage Output current (both diodes conducting)	0.95 16	0.95 16	0.95 16	V A
t <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Repetitive peak reverse current per diode	25 0.2	25 0.2	25 0.2	ns A

### **PIN CONFIGURATION**

# PINDESCRIPTION1no connection2cathode3anodembcathode



### SYMBOL



### LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.		UNIT	
V <sub>rrm</sub> V <sub>rwm</sub> V <sub>r</sub>	Repetitive peak reverse voltage Crest working reverse voltage Continuous reverse voltage			<b>-100</b> 100 100 100	<b>-150</b> 150 150 150	<b>-200</b> 200 200 200	V V V
I <sub>O(AV)</sub>	Output current (both diodes conducting) <sup>1</sup>	square wave $\delta = 0.5$ ; T <sub>mb</sub> $\leq 104$ °C	-		16		A
I <sub>O(RMS)</sub>	RMS forward current		-		23		A
I <sub>FRM</sub>	Repetitive peak forward current per diode	t = 25 μs; δ = 0.5; T <sub>mb</sub> ≤ 104 °C	-		16		А
I <sub>FSM</sub>	Non-repetitive peak forward current per diode	t = 10 ms t = 8.3 ms sinusoidal; with reapplied	-		100 110		A A
l <sup>2</sup> t	I <sup>2</sup> t for fusing	$V_{\text{RWM(max)}}$ t = 10 ms	-		50		A <sup>2</sup> s
I <sub>RRM</sub>		$t_p = 2 \ \mu s; \ \delta = 0.001$	-		0.2		A
I <sub>RSM</sub>	Non-repetitive peak reverse current per diode	t <sub>p</sub> = 100 μs	-		0.2		А
T <sub>stg</sub>	Storage temperature		-40		150		°C
T <sub>j</sub>	Operating junction temperature		-		150		°C

**<sup>1</sup>** Neglecting switching and reverse current losses.

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### ESD LIMITING VALUE

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>c</sub>	Electrostatic discharge capacitor voltage	Human body model; C = 250 pF; R = 1.5 k $\Omega$	-	8	kV

#### THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R <sub>th j-mb</sub> R <sub>th j-a</sub>	Thermal resistance junction to mounting base Thermal resistance junction to ambient	per diode both diodes conducting minimum footprint, FR4 board	- -	- - 50	3.0 2.5 -	K/W K/W K/W

### STATIC CHARACTERISTICS

 $T_i = 25$  °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>F</sub>	Forward voltage (per diode)	I <sub>F</sub> = 8 A; T <sub>i</sub> = 150°C I <sub>F</sub> = 16 A; T <sub>i</sub> = 150°C	-	0.83	0.95	V
		I <sub>F</sub> = 16 A; T <sub>i</sub> = 150°C	-	1.0	1.15	V
		$I_{\rm F} = 16  {\rm A};$	-	0.98	1.25	
I <sub>R</sub>	Reverse current (per diode)	$\dot{V}_{R} = V_{RWM}; T_{i} = 100 \text{ °C}$	-	0.3	0.6	mA
		$V_{R} = V_{RWM}$	-	2	30	μA

### **DYNAMIC CHARACTERISTICS**

 $T_i = 25$  °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Q <sub>s</sub>	Reverse recovery charge (per diode)	$I_{\text{F}} = 2 \text{ A};  V_{\text{R}} \geq 30  \text{V};  \text{-d}I_{\text{F}}\text{/d}t = 20  \text{A}\text{/}\mu\text{s}$	-	4	11	nC
t <sub>rr</sub>	Reverse recovery time (per diode)	I <sub>F</sub> = 1 A; V <sub>R</sub> ≥ 30 V; -dI <sub>F</sub> /dt = 100 A/μs	-	20	25	ns
I <sub>rrm</sub>	Peak reverse recovery current (per diode)	I <sub>F</sub> = 1 A; V <sub>R</sub> ≥ 30 V; -dI <sub>F</sub> /dt = 50 A/µs; T <sub>i</sub> = 100 °C	-	1.0	2	А
V <sub>fr</sub>	Forward recovery voltage (per diode)	$I_F = 1 \text{ A}; dI_F/dt = 10 \text{ A}/\mu \text{s}$	-	1	-	V

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#### Product specification

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### **MECHANICAL DATA**



#### Notes

1. Epoxy meets UL94 V0 at 1/8".

### **MOUNTING INSTRUCTIONS**



#### Notes

1. Plastic meets UL94 V0 at 1/8".

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### DEFINITIONS

Data sheet status					
Objective specification	tion This data sheet contains target or goal specifications for product development.				
Preliminary specification	Preliminary specification This data sheet contains preliminary data; supplementary data may be published later.				
Product specification	tion This data sheet contains final product specifications.				
Limiting values					
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.					

#### Application information

Where application information is given, it is advisory and does not form part of the specification.

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